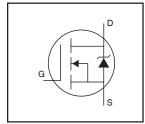
International IOR Rectifier

AUIRF3305

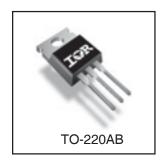
HEXFET® Power MOSFET

Features

- Advanced Planar Technology
- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *



V _{(BR)DSS}	55V
R _{DS(on)} max.	$8 m \Omega$
I _D	140A



G	D	S
Gate	Drain	Source

Description

Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	140	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	99	А
I _{DM}	Pulsed Drain Current ①	560	
P _D @T _C = 25°C	Power Dissipation	330	W
	Linear Derating Factor	2.2	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy(Thermally limited) ②	470	mJ
E _{AS} (Tested)	Single Pulse Avalanche Energy Tested Value © 6	860	mJ
I _{AR}	Avalanche Current ①	See Fig.12a, 12b, 15, 16	А
E _{AR}	Repetitive Avalanche Energy ®		mJ
TJ	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds(1.6mm from case)	300	
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

	Davamatav	Time	Max	I I mila
	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ♥		0.45	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta,JA}$	Junction-to-Ambient		62	

HEXFET® is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	_	0.055		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			8.0	mΩ	V _{GS} = 10V, I _D = 75A ③⑧
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
gfs	Forward Transconductance	41			S	V _{DS} = 25V, I _D = 75A®
I _{DSS}	Drain-to-Source Leakage Current	_		25	μΑ	$V_{DS} = 55V, V_{GS} = 0V$
				250	İ	$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage	_		200	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage	_		-200		V _{GS} = -20V
Q _g	Total Gate Charge		100	150	0	I _D = 75A ®
Dynamic Ele	ctrical Characteristics @ T _J = 25°C ((unless d	otherwi	se spe	cified)	
$\overline{Q_gs}$	Gate-to-Source Charge	+	21		nC	V _{DS} = 44V
$\overline{Q_{gd}}$	Gate-to-Drain ("Miller") Charge		45			V _{GS} = 10V ③
t _{d(on)}	Turn-On Delay Time		16			V _{DD} = 28V
t _r	Rise Time		88		•	I _D = 75A ®
t _{d(off)}	Turn-Off Delay Time	—	43		ns	$R_G = 2.6 \Omega$
t _f	Fall Time		34		İ	V _{GS} = 10V ③
L _D	Internal Drain Inductance		4.5			Between lead,
					nH	6mm (0.25in.)
L _S	Internal Source Inductance	T	7.5		Ī	from package
						and center of die contact
C _{iss}	Input Capacitance	<u> </u>	3650			V _{GS} = 0V
Coss	Output Capacitance	 	1230		1	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance	T	450		pF	f = 1.0MHz
Coss	Output Capacitance	—	4720		1	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		930		1	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			75		MOSFET symbol
	(Body Diode)				Α	showing the
I _{SM}	Pulsed Source Current			560		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25$ °C, $I_S = 75A$ ®, $V_{GS} = 0V$ ③
t _{rr}	Reverse Recovery Time		57	86	ns	$T_J = 25^{\circ}C$, $I_F = 75A$ $\$$, $V_{DD} = 28V$
Q _{rr}	Reverse Recovery Charge		130	190	nC	di/dt = 100A/µs ③
t _{on}	Forward Turn-On Time	Intrinsic t	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			

1490

Notes:

Coss eff.

- ① Repetitive rating; pulse width limited by max. junction temperature.
- V_{GS} =10V. Part not recommended for use above this value.

Effective Output Capacitance

- $\ensuremath{\mathfrak{G}}$ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- avalanche performance.
- © This value determined from sample failure population. 100% tested to this value in production.

 $V_{GS} = 0V, V_{DS} = 0V \text{ to } 44V \oplus$

- ® All AC and DC test conditions based on former package limited current of 75A.

Qualification Information[†]

Qualification Level		Automotive				
		(per AEC-Q101) ††				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		3L-TO-220 N/A				
	Manhina Madal	Class M4(425V)				
	Machine Model	(per AEC-Q101-002)				
FOD	Llowe en De do Ma del	Class H2 (4000V)				
ESD	Human Body Model	(per AEC-Q101-001)				
	Charried Davies Madel	Class C5 (1125V)				
	Charged Device Model		(per AEC-Q101-005)			
RoHS Compliant		Yes				

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.

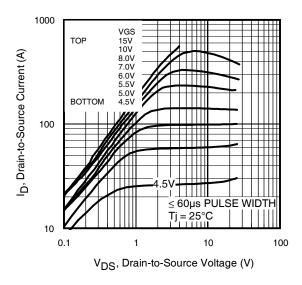


Fig 1. Typical Output Characteristics

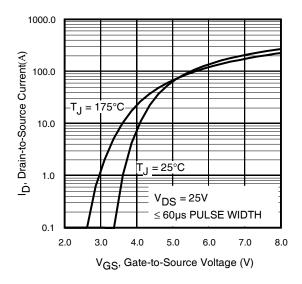


Fig 3. Typical Transfer Characteristics

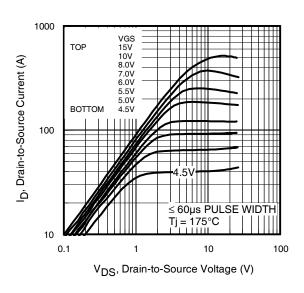


Fig 2. Typical Output Characteristics

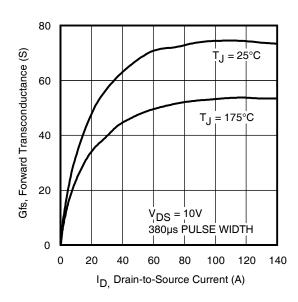


Fig 4. Typical Forward Transconductance Vs. Drain Current

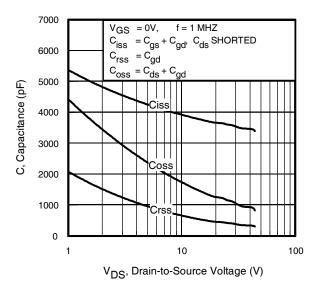


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

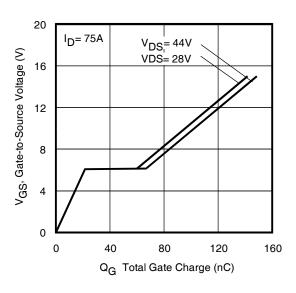


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

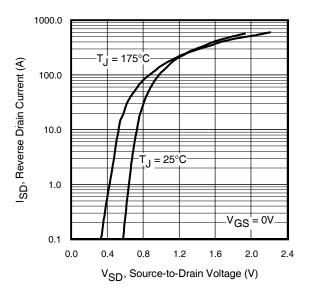


Fig 7. Typical Source-Drain Diode Forward Voltage

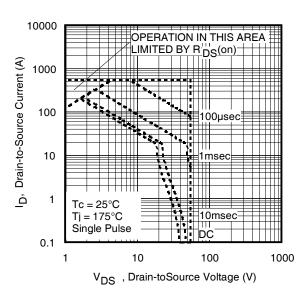
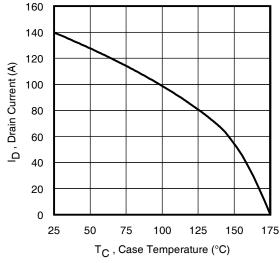


Fig 8. Maximum Safe Operating Area





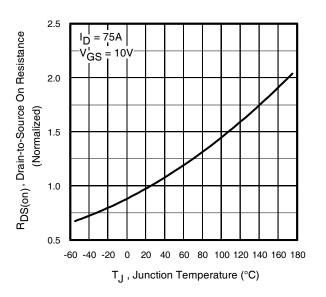


Fig 10. Normalized On-Resistance Vs. Temperature

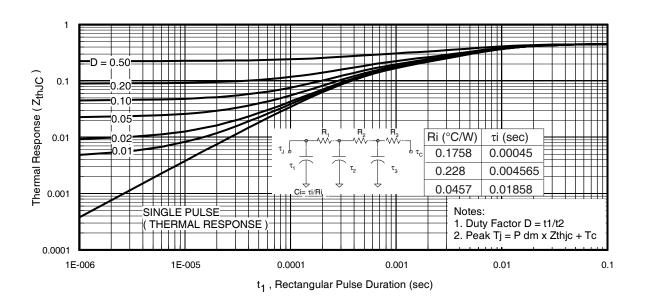


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

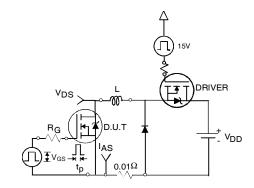


Fig 12a. Unclamped Inductive Test Circuit

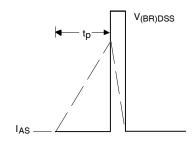


Fig 12b. Unclamped Inductive Waveforms

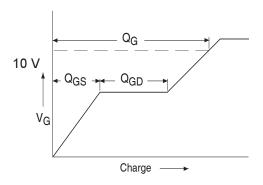


Fig 13a. Basic Gate Charge Waveform

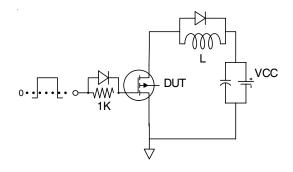


Fig 13b. Gate Charge Test Circuit

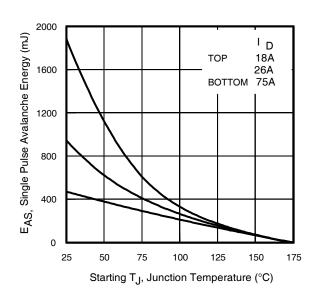


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

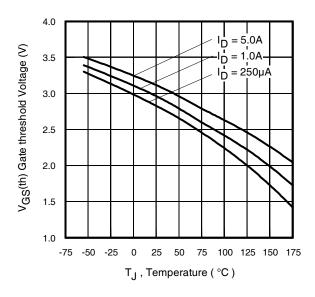


Fig 14. Threshold Voltage Vs. Temperature

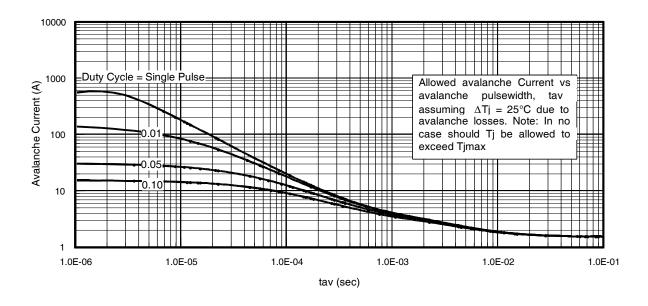


Fig 15. Typical Avalanche Current Vs. Pulsewidth

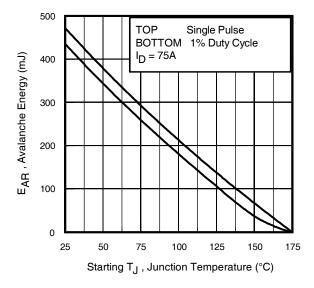


Fig 16. Maximum Avalanche Energy Vs. Temperature

Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
 - Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- P_{D (ave)} = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).

 t_{av} = Average time in avalanche.

 $D = Duty cycle in avalanche = t_{av} \cdot f$

 $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D~(ave)} &= 1/2~(~1.3 \cdot BV \cdot I_{av}) = \triangle T/~Z_{thJC} \\ I_{av} &= 2\triangle T/~[1.3 \cdot BV \cdot Z_{th}] \\ E_{AS~(AR)} &= P_{D~(ave)} \cdot t_{av} \end{split}$$

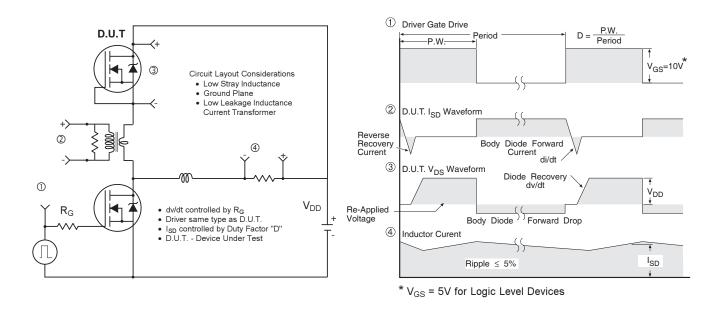


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

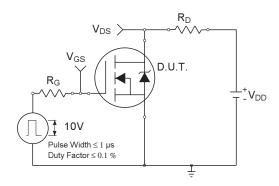


Fig 18a. Switching Time Test Circuit

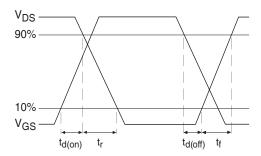


Fig 18b. Switching Time Waveforms

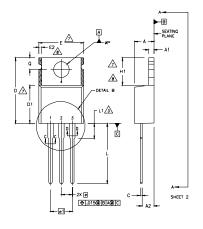
LEAD ASSIGNMENTS

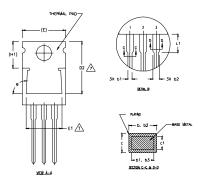
HEXFET

1.- GATE

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.
- DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS].
- LEAD DIMENSION AND FINISH UNCONTROLLED IN LI
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

DIMENSION b1 & c1 APPLY TO BASE METAL ONLY.

SYMBOL

Α1

A2

b

ь1

b2 b3

С

c1

D

D1

D2

E1

е e1 Н1

L L1

øΡ

Q

CONTROLLING

0.36

0.36

14,22

8.38

12.19

9.66

8.38

12.70

3.54

2.54

THERMAL PAD

0.61

0.56

16.51

9.02

12.88

10,66

8.89

14,73

6.35

4.08

3.42

.014

.014

.560

.330

.480

.380

.330

.230

.500

.139

- DIMENSION E2 AND SINGULA

AD CONTOL	ON : INCHES, JR OPTIONAL W DEFINE A ZONE REGULARITIES A	WHERE STAMP		E1	2 DRAIN 3 SOURCE IGBTs, Copack 1 Gate 2 Collector 3 EMITTER
	DIMEN	ISIONS			DIODES
MILLIN	ILLIMETERS INCHES		INCHES		1,- ANODE/OPE 2 CATHODE
MIN.	MAX.	MIN.	MAX.	NOTES	3,- ANODE
3.56	4,82	.140	.190		
0.51	1.40	.020	.055		
2.04	2.92	.080	.115		
0.38	1,01	.015	.040		
0.38	0.96	.015	.038	5	
1.15	1,77	.045	.070		
1.15	1.73	.045	.068		

.024

.022

.650

.355

.507

.420

.350

.270

.580

.250

.161

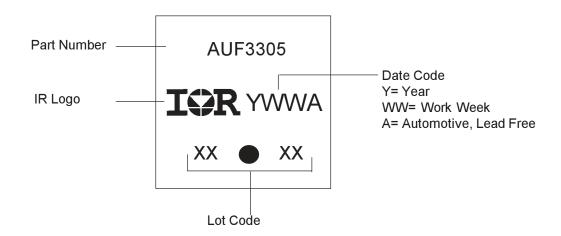
.135

5

4,7

7,8

TO-220AB Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF3305	TO-220	Tube	50	AUIRF3305

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